

NCE N-Channel Enhancement Mode Power MOSFET

Description

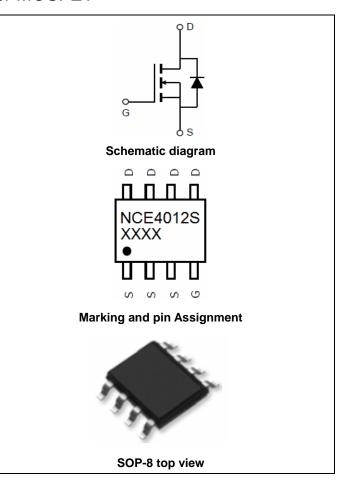
The NCE4012S uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

- V_{DS} =40V,I_D =12A
 - $R_{DS(ON)}$ <12m Ω @ V_{GS} =10V (Typ. 8.4 m Ω)
 - $R_{DS(ON)}$ <18m Ω @ V_{GS} =4.5V (Typ. 12.3 m Ω)
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

- Load switching
- Hard switched and high frequency circuits
- Uninterruptible power supply



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE4012S	NCE4012S	SOP-8	Ø330mm	12mm	2500 units

Absolute Maximum Ratings (T_A=25 ℃unless otherwise noted)

About the Maximum Ratings (TA-20 Samoss Samoss Samoss Moss Moss Mossa)						
Parameter	Symbol	Limit	Unit			
Drain-Source Voltage	V _{DS}	40	V			
Gate-Source Voltage	V _{GS}	±20	V			
Drain Current-Continuous	I _D	12	А			
Drain Current-Continuous(T _C =100 °C)	I _D (100℃)	8.5	А			
Pulsed Drain Current	I _{DM}	60	Α			
Maximum Power Dissipation	P _D	3	W			
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 150	$^{\circ}\!\mathbb{C}$			

Thermal Characteristic

Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{\theta JA}$	41.7	°C/W
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Electrical Characteristics (T_A=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit



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NCE4012S

Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	40	45	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =40V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	·		•			
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1.2	1.6	2.5	V
Durain Courses On Otata Basistanas	Б	V _{GS} =10V, I _D =10A	-	8.4	12	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =8A	-	12.3	18	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =10A		75	-	S
Dynamic Characteristics (Note4)			,	•		
Input Capacitance	C _{lss}	\/ -20\/\/ -0\/	-	1780	-	PF
Output Capacitance	C _{oss}	V_{DS} =20V, V_{GS} =0V, F=1.0MHz	-	209	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.UIVIHZ	-	160	-	PF
Switching Characteristics (Note 4)	•		•			
Turn-on Delay Time	t _{d(on)}		-	6.4	-	nS
Turn-on Rise Time	t _r	V_{DD} =20V, R_L =2 Ω	-	17.2	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{G} =3 Ω	-	29.6	-	nS
Turn-Off Fall Time	t _f		-	16.8	-	nS
Total Gate Charge	Qg	V 00VI 40A	-	30		nC
Gate-Source Charge	Q _{gs}	V _{DS} =20V,I _D =10A,	-	4.2		nC
Gate-Drain Charge	Q_{gd}	V _{GS} =10V	-	9.5		nC
Drain-Source Diode Characteristics			•			
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =10A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	12	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = 10A	-	29	-	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	26	-	nC

Notes:

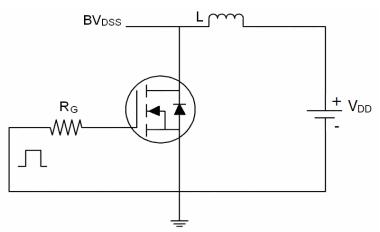
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production

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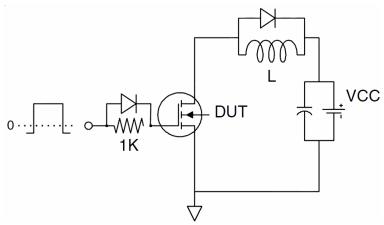
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Test circuit

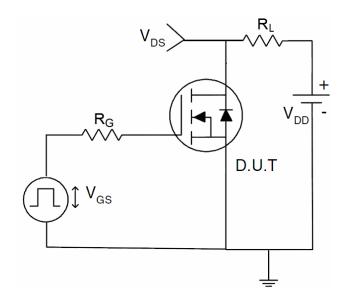
1) E_{AS} Test Circuit



2) Gate Charge Test Circuit



3) Switch Time Test Circuit



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Typical Electrical and Thermal Characteristics (Curves)

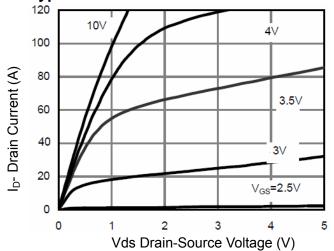


Figure 1 Output Characteristics

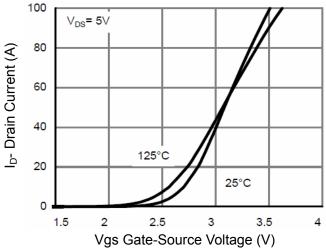


Figure 2 Transfer Characteristics

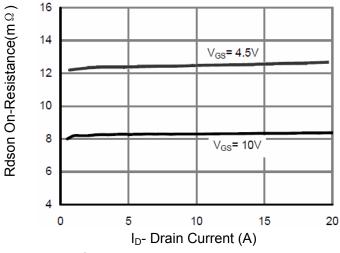


Figure 3 Rdson- Drain Current

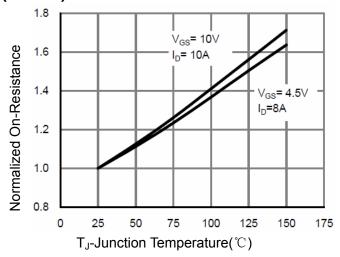


Figure 4 Rdson-JunctionTemperature

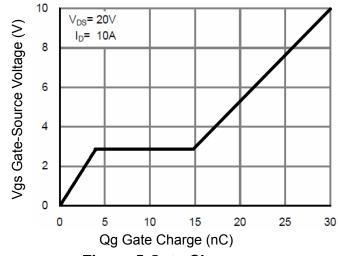


Figure 5 Gate Charge

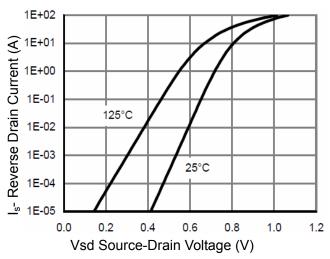
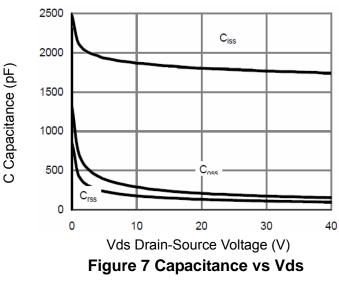


Figure 6 Source- Drain Diode Forward





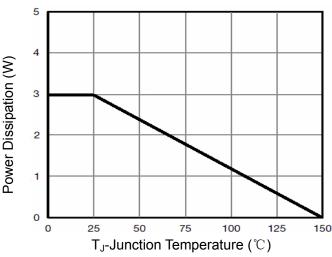
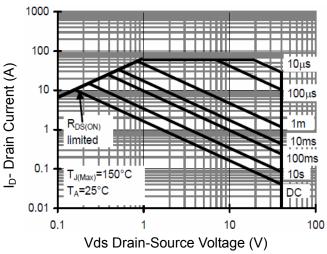


Figure 9 Power De-rating



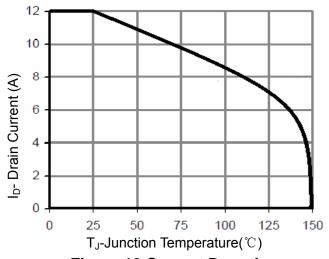
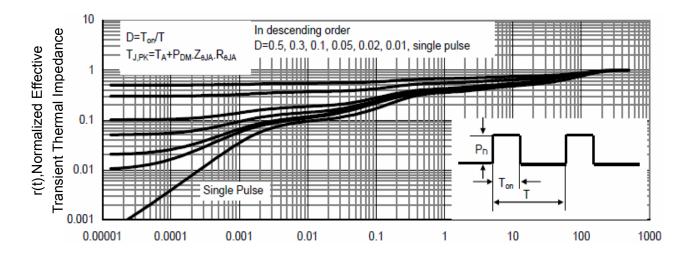


Figure 8 Safe Operation Area

Figure 10 Current De-rating

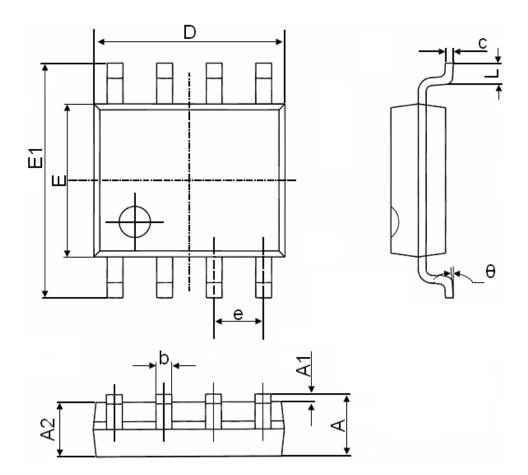


Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance



SOP-8 Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.170	0.250	0.006	0.010	
D	4.700	5.100	0.185	0.200	
E	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
е	1.270	(BSC)	0.050(BSC)		
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	



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